

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized applications, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an equif prese



August 2011

FMS6144A Four-Channel, 6th-Order SD VoltagePlus[™] Video Filter Driver

Features

- Four-Channel 6th-Order 8MHz (SD) Filter
- Drives Single, AC- or DC-Coupled Video Loads (150Ω)
- **Transparent Input Clamping**
- Supply Range: 3.3V to 5.0V
- AC- or DC-Coupled Inputs and Outputs
- Robust 9kV ESD Protection
- Lead-Free TSSOP 14-Pin Package

Applications

- Cable Set-Top Boxes
- Satellite Set-Top Boxes
- . **DVD** Players
- HDTV
- -Personal Video Recorders (PVR)
- Video On Demand (VOD)

Description

The FMS6144A VoltagePlus™ video filter is intended to replace passive LC filters and drivers with a costeffective integrated device. Four 6th-order filters provide improved image quality compared to typical 2nd and 3rd order passive solutions.

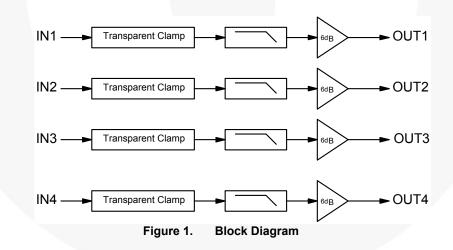
The FMS6144A may be directly driven by a DC-coupled DAC output or an AC-coupled signal. Internal diode clamps and bias circuitry may be used if AC-coupled inputs are required (see the Applications section for details).

The outputs can drive AC- or DC-coupled single (150 Ω) or dual (75 Ω) video loads. DC coupling the outputs removes the need for large output coupling capacitors. The input DC levels are offset approximately +280mV at the output (see the Applications section for details).

Related Applications Notes

AN-6024 – FMS6xxx Product Series Understanding Analog Video Signal Clamps, Bias, DC Restore, and AC or DC coupling Methods

AN-6041 – PCB Layout Considerations for Video Filter / Drivers



Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FMS6144AMTC14X	-40°C to +85°C	14-Lead TSSOP	2500 per Reel

			1.1
1	IN1	OUT1	14
2	IN2	OUT2	13
3	IN3	OUT3	12
4	IN4	OUT4	11
5	GND	VCC	10
6	NC	NC	9
7	NC	NC	8

Figure 2. 14-Lead TSSOP (Top View)

Pin Definitions

Pin#	Name	Туре	Description
1	IN1	Input	Video Input Channel 1
2	IN2	Input	Video Input Channel 2
3	IN3	Input	Video Input Channel 3
4	IN4	Input	Video Input Channel 4
5	GND	Input	Device Ground Connection
6	NA	NA	No Connection
7	NA	NA	No Connection
8	NA	NA	No Connection
9	NA	NA	No Connection
10	Vcc	Input	Positive Power Supply
11	OUT4	Output	Filtered Output Channel 4
12	OUT3	Output	Filtered Output Channel 3
13	OUT2	Output	Filtered Output Channel 2
14	OUT1	Output	Filtered Output Channel 1

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	DC Supply Voltage	-0.3	6.0	V
V _{IO}	Analog and Digital I/O	-0.3	V _{CC} +0.3	V
V _{OUT}	Maximum Output Current, Do Not Exceed		50	mA

Electrostatic Discharge Information

Symbol	Parameter	Min	Unit
Human Body Model, JESD22-A114		9	
ESD	Charged Device Model, JESD22-C101	2	kV

Reliability Information

Symbol	Parameter	Min.	Тур.	Max.	Unit
TJ	Junction Temperature			+150	°C
T _{STG}	Storage Temperature Range	-65		+150	°C
TL	Lead Temperature (Soldering, 10 Seconds)			+300	°C
Θ_{JA}	Thermal Resistance, JEDEC Standard, Multilayer Test Boards, Still Air		90		°C/W

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Тур.	Max.	Unit
T _A	Operating Temperature Range	-40		+85	°C
V _{cc}	Supply Voltage Range	3.14	3.30	5.25	V

DC Electrical Characteristics

 $T_A=25^{\circ}C$, $V_{CC}=3.3V$, $R_S=37.5\Omega$, all inputs are AC-coupled with 0.1uF, and all outputs are AC coupled with 220µF into 150 Ω load; unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Supply						
V _{cc}	Supply Voltage Range	V _S Range	3.14	3.30	5.25	V
1	$O_{\rm rel}$	V _S =+3.3V, No Load		21	24	m A
I _{CC}	Quiescent Supply Current ⁽¹⁾	V _S =+5.0V, No Load		25	29	mA
V _{IN}	Video Input Voltage Range	Referenced to GND if DC Coupled		1.4		V_{PP}
PSRR	Power Supply Rejection Ratio	DC (all Channels)		-65		dB

Note:

1. 100% tested at $T_A=25^{\circ}C$

AC Electrical Characteristics

 T_A =25°C, V_{CC} =3.3V, R_S =37.5 Ω , all inputs are AC-coupled with 0.1 μ F, and all outputs are AC coupled with 220 μ F into 150 Ω load, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
AV	Channel Gain ⁽²⁾	Active Video Input Range = 1V _{PP}	5.8	6.0	6.2	dB
$BW_{0.1dB}$	±0.1dB Bandwidth	R_{SOURCE} =75 Ω , R_{L} =150 Ω		5		MHz
BW-1.0dB	-1.0 dB Bandwidth	R_{SOURCE} =75 Ω , R_{L} =150 Ω		7		MHz
BW _{3.0dB}	-3.0 dB Bandwidth	R_{SOURCE} =75 Ω , $R_{L=}$ 150 Ω		8		MHz
Att _{27M}	Normalized Stopband Attenuation ⁽²⁾	R _{SOURCE} =75Ω, f=27MHz	45	60		dB
DG	Differential Gain - NTSC/PAL	Active Video Input Range = 1V _{PP}		0.6		%
DP	Differential Phase - NTSC/PAL	Active Video Input Range = 1V _{PP}		0.6		٥
THD	Total Harmonic Distortion	f=1.00MHz; V _{OUT} =1.4V _{PP}		0.2		%
X _{talk}	Crosstalk (Channel to Channel)	f=1.00MHz; V _{OUT} =1.4V _{PP}		-65		dB
SNR	Peak Signal to RMS Noise	NTC-7 Weighting: 100kHz to 4.2MHz		74		dB
T_{pd}	Propagation Delay	Delay from Input to Output; 100KHz to 4.5MHz		90		ns
CLG	Chroma-Luma Gain ⁽²⁾	400Khz to 3.58Mhz	95	100	105	%
CLD	Chroma-Luma Delay	400Khz to 3.58Mhz		7.5		ns

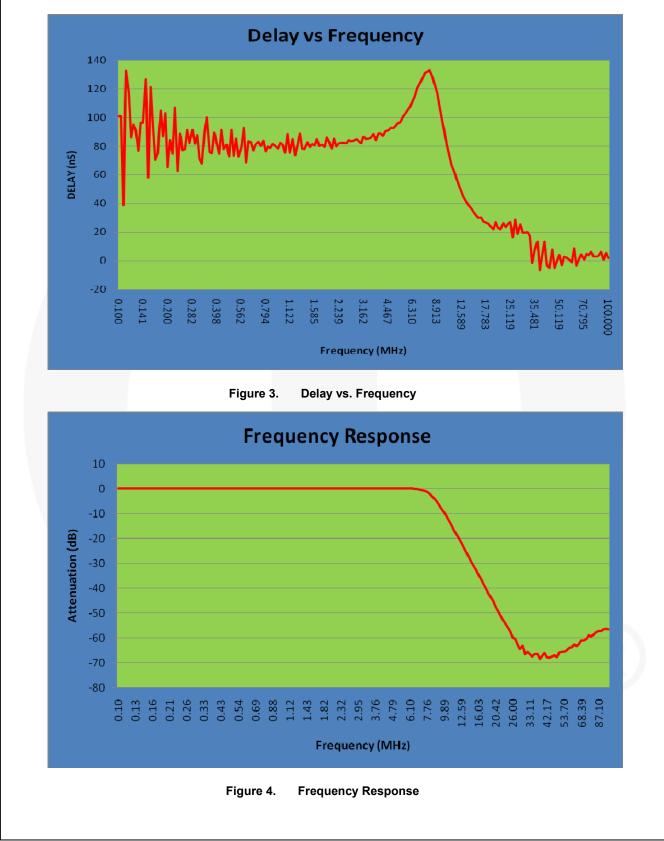
Note:

2. 100% tested at $T_A=25^{\circ}C$

FMS6144A —Four-Channel, 6th-Order SD VoltagePlus™ Video Filter Driver

Typical Performance Characteristics

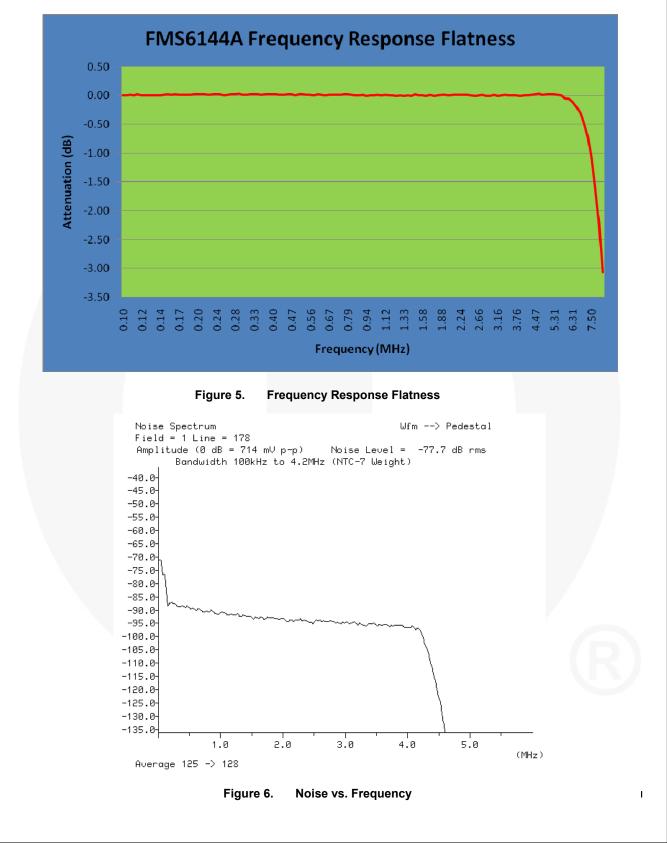
Unless otherwise noted, T_A = 25°C, V_{CC} = 2.7V, R_S = 37.5 Ω , and AC-coupled output into 150 Ω load.



FMS6144A —Four-Channel, 6th-Order SD VoltagePlus[™] Video Filter Driver

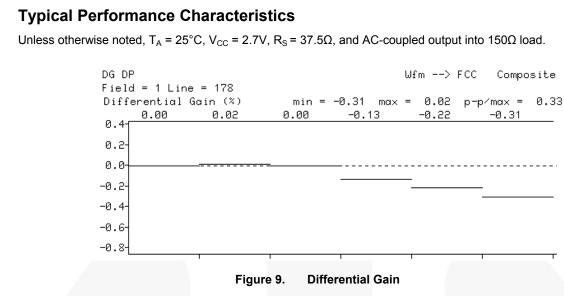
Typical Performance Characteristics

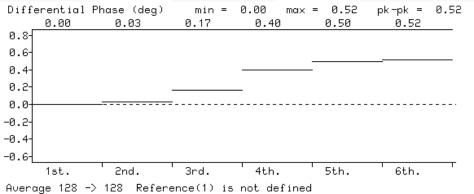
Unless otherwise noted, $T_A = 25^{\circ}$ C, $V_{CC} = 2.7$ V, $R_S = 37.5\Omega$, and AC-coupled output into 150 Ω load.



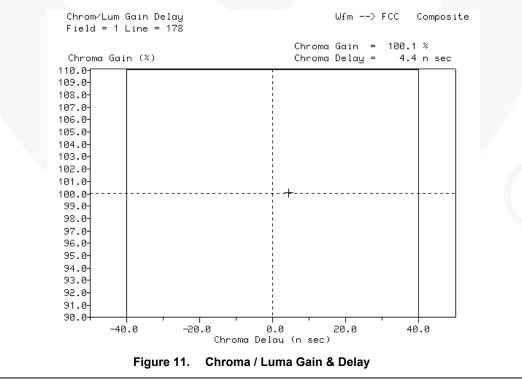
Composite

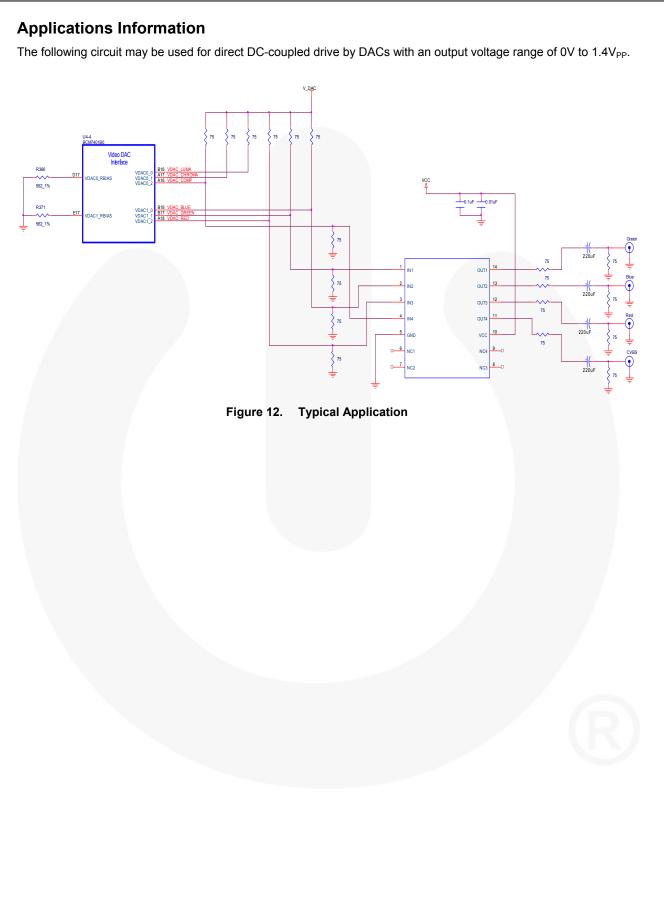
-0.31







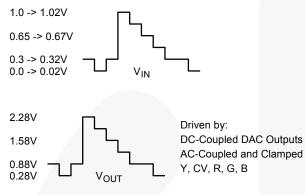




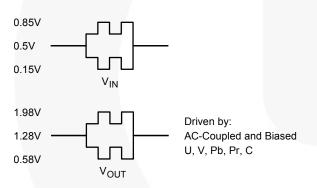
Application Information

Application Circuits

The FMS6144A VoltagePlus[™] video filter provides 6dB gain from input to output. In addition, the input is slightly offset to optimize the output driver performance. The offset is held to the minimum required value to decrease the standing DC current into the load. Typical voltage levels are shown in Figure 13:



There is a 280mV offset from the DC input level to the ^L DC output level. V $_{OUT}$ = 2 * V $_{IN}$ + 280mV.





The FMS6144A provides an internal diode clamp to support AC-coupled input signals. If the input signal does not go below ground, the input clamp does not operate. This allows DAC outputs to directly drive the FMS6144A without an AC-coupling capacitor. When the input is AC coupled, the diode clamp sets the sync tip (or lowest voltage) just below ground. The worst-case sync tip compression due to the clamp cannot exceed 7mV. The input level set by the clamp, combined with the internal DC offset, keeps the output within its acceptable range.

For symmetric signals like Chroma, U, V, Pb, and Pr; the average DC bias is fairly constant and the inputs can be AC-coupled with the addition of a pull-up resistor to set the DC input voltage. DAC outputs can also drive these same signals without the AC coupling capacitor. A conceptual illustration of the input clamp circuit is shown in Figure 14.

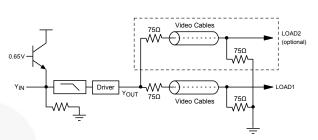


Figure 14. Input Clamp Circuit

I/O Configurations

For a DC-coupled DAC drive with DC-coupled outputs, use the configurationin Figure 15.

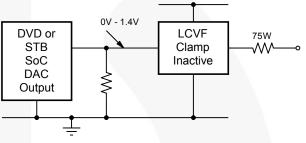


Figure 15. DC-Coupled Inputs and Outputs

Alternatively, if the DAC's average DC output level causes the signal to exceed the range of 0V to 1.4V, it can be AC coupled as follows:

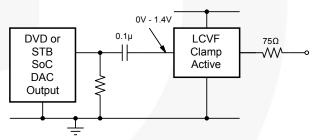
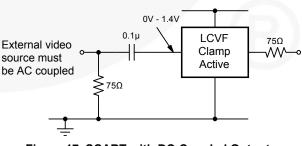
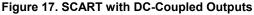


Figure 16. AC-Coupled Inputs, DC-Coupled Outputs

When FMS6144A is driven by an unknown external source or a SCART switch with its own clamping circuitry, the inputs should be AC coupled like Figure 17.





(2)

(3)

(4)

The same method can be used for biased signals, with the addition of a pull-up resistor to make sure the clamp never operates. The internal pull-down resistance is 800k Ω ±20%, so the external resistance should be 7.5M Ω to set the DC level to 500mV.

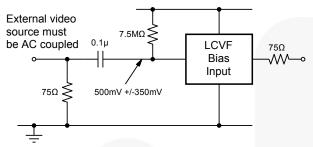


Figure 18. Biased SCART with DC-Coupled Outputs

The same circuits can be used with AC-coupled outputs if desired.

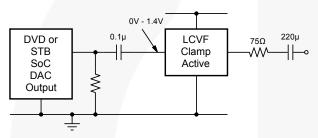


Figure 19. DC-Coupled Inputs, AC-Coupled Outputs

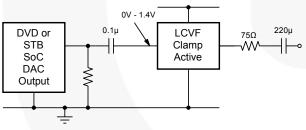


Figure 20. AC-Coupled Inputs and Outputs

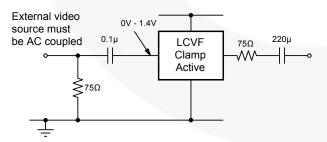


Figure 21. Biased SCART with AC-Coupled Outputs

NOTE: The video tilt or line time distortion is dominated by the AC-coupling capacitor. The value may need to be increased beyond 220μ F to obtain satisfactory operation in some applications.

Power Dissipation

The output drive configuration must be considered when calculating overall power dissipation. Care must be taken not to exceed the maximum die junction temperature. The following example can be used to calculate the power dissipation and internal temperature rise.

$$T_{J} = T_{A} + P_{D} \cdot \theta_{JA} \tag{1}$$

where:
$$P_{D} = P_{CH1} + P_{CH2} + P_{CH3}$$

and

 $\mathsf{P}_{\mathsf{CHX}} = \mathsf{V}_{\mathsf{CC}} \cdot \mathsf{I}_{\mathsf{CH}} - (\mathsf{V}_{\mathsf{O}}^2/\mathsf{R}_{\mathsf{L}})$

where:

$$V_{\rm O} = 2V_{\rm IN} + 0.280V$$

$$I_{CH} = (I_{CC}/3) + (V_O/R_L)$$
(5)

 V_{IN} = RMS value of input signal

 $I_{CC} = 19 mA$

 $V_{CC} = 3.3V.$

R_L = channel load resistance

Board layout can also affect thermal characteristics. Refer to the *Layout Considerations* section for details.

The FMS6144A is specified to operate with output currents typically less than 50mA, more than sufficient for a dual (75 Ω) video load. Internal amplifiers are current limited to a maximum of 100mA and should withstand brief-duration short-circuit conditions. This capability is not guaranteed.

Layout Considerations

General layout and supply bypassing play a major role in high-frequency performance and thermal characteristics. Fairchild offers a four-layer board with full power and ground planes board to guide layout and aid device evaluation. The demo board is a four-layer board with full power and ground planes. Following this layout configuration provides optimum performance and thermal characteristics for the device. For best results, follow the steps and recommended routing rules below.

Recommended Routing / Layout Rules

- Do not run analog and digital signals in parallel.
- Use separate analog and digital power planes to supply power.
- Traces should run on top of the ground plane at all times.
- No trace should run over ground/power splits.
- Avoid routing at 90-degree angles.
- Minimize clock and video data trace length differences.
- Include 10µF and 0.1µF ceramic power supply bypass capacitors.
- Place the 0.1µF capacitor within 2.54mm (0.1in) of the device power pin.
- Place the 10µF capacitor within 19.05mm (0.75in) of the device power pin.
- For multi-layer boards, use a large ground plane to help dissipate heat.
- For two-layer boards, use a ground plane that extends beyond the device body at least 12.7mm (0.5in) on all sides. Include a metal paddle under the device on the top layer.
- Minimize all trace lengths to reduce series inductance.

Output Considerations

The outputs are DC offset from the input by 150mV therefore V_{OUT} = $2 \cdot V_{IN}$ DC + 150mV. This offset is required for optimal performance from the output driver and is held at the minimum value to decrease the standing DC current into the load. Since the FMS6144A has a 2x (6dB) gain, the output is typically connected via a 75 Ω series back-matching resistor followed by the 75 Ω video cable. Because of the inherent divide by two of this configuration, the blanking level at the load of the video signal is always less than 1V. When AC-coupling the output, ensure that the coupling capacitor passes the lowest frequency content in the video signal and that line time distortion (video tilt) is kept as low as possible.

The selection of the coupling capacitor is a function of the subsequent circuit input impedance and the leakage current of the input being driven. To obtain the highest quality output video signal, the series termination resistor must be placed as close to the device output pin as possible. This greatly reduces the parasitic capacitance and inductance effect on the output driver. The distance from the device pin to the series termination resistor should be no greater than 2.54mm (0.1in).

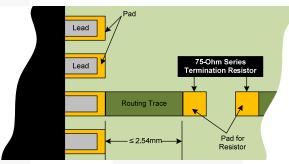


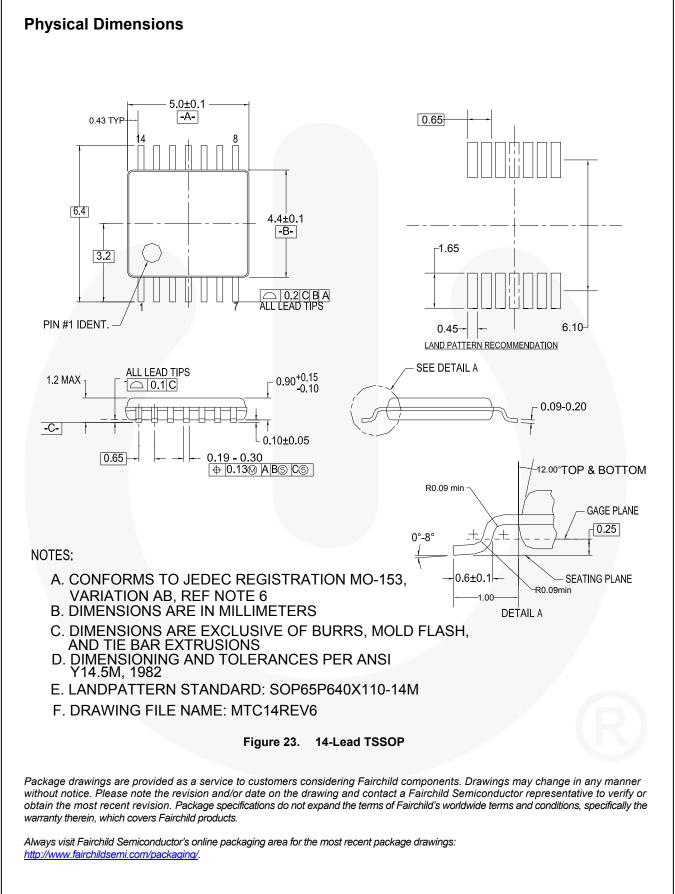
Figure 22. Termination Resistor Placement

Thermal Considerations

Since the interior of most systems, such as set-top boxes, TVs, and DVD players; are at +70°C; consideration must be given to providing an adequate heat sink for the device package for maximum heat dissipation. When designing a system board, determine how much power each device dissipates. Ensure that devices of high power are not placed in the same location, such as directly above (top plane) or below (bottom plane) each other, on the PCB.

PCB Thermal Layout Considerations

- Understand the system power requirements and environmental conditions.
- Maximize thermal performance of the PCB.
- Consider using 70µm of copper for high-power designs.
- Make the PCB as thin as possible by reducing FR4 thickness.
- Use vias in power pad to tie adjacent layers together.
- Remember that baseline temperature is a function of board area, not copper thickness.
- Modeling techniques provide a first-order approximation.



FAIRCHILD

SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

	or an oddin Bladdinianto.		
2Cool™	FPS™	PDP SPM™	The Power Franchise®
AccuPower™	F-PFS™	Power-SPM™	the
Auto-SPM™	FRFET®	PowerTrench [®]	
AX-CAP™*	Global Power Resource sm	PowerXS™	TinyBoost™
BitSiC®	Green FPS™	Programmable Active Droop™	
Build it Now™	Green FPS™ e-Series™	QFET [®]	TinyBuck™ TinγCalc™
CorePLUS™	G <i>m</i> ax™	QS™	TinyLogic®
CorePOWER™	GTO™	Quiet Series™	TINYOPTOM
CROSSVOLT™	IntelliMAX™	RapidConfigure™	TinyPower™
CTL™	ISOPLANAR™		
Current Transfer Logic™ DEUXPEED® Dual Cool™ EcoSPARK® EfficientMax™ ESBC™ Fairchild® Fairchild® Fairchild Semiconductor® FACT Quiet Series™ FACT® FAST® FAST® FastyCore™ FETBench™ FIashWriter®*	Making Small Speakers Sound Louder and Better™ MegaBuck™ MICROCOUPLER™ MicroPak™ MicroPak™ MicroPak2™ MotionMax™ MotionMax™ MotionSPM™ mWSaver™ OptoHiT™ OPTOLOGIC [©] OPTOPLANAR [®]	Saving our world, 1mWWW/kW at a time™ SignalWise™ SmartMax™ SMART START™ SPM® STEALTH™ SuperFET® SuperSOT™-8 SuperSOT™-8 SuperSOT™-8 SuperSOT™-8 SuperFET™ SyncFET™ SyncFET™	TinyPWM™ TinyWire™ TranSiC® TriFault Detect™ TRUECURRENT®* µSerDes™ WSerDes™ UHC® UHCP UItra FRFET™ UniFET™ VCX™ VisualMax™ VotagePlus™ XS™

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized.

PRODUCT STATUS DEFINITIONS

Definition of Terms		
Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 157

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death a

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Active Filters category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

VEMI256A-SD2-G4-08 HMC894LP5ETR HMC896LP4ETR HMC891LP5ETR MAX7491CEE+ MAX7413CUA+ MAX7411CUA+ MAX281AEWE+ MAX280EPA+ MAX274AENG+ LTC1064-3CSW#PBF LTC1060ACN#PBF LTC1069-1IS8#PBF LTC1164CSW#PBF LTC1164-6CSW#PBF LTC1064-2CSW#PBF LTC1569CS8-7#PBF LTC1164ACSW#PBF LTC1067-50CS#PBF LTC1164-6CN#PBF LTC1059CN#PBF LTC1069-1CN8#PBF LTC1069-7IS8#PBF LTC1069-6CS8#PBF LTC1562IG-2#PBF LTC1164-5CSW#PBF LTC1566-1CS8#PBF LTC1064-7CN#PBF LTC1063CN8#PBF LTC1062CN8#PBF LTC6603IUF#PBF LTC1061ACN#PBF LTC1061CN#PBF LTC1264CN#PBF LTC1562ACG#PBF LTC1562AIG#PBF LTC1164-7CSW#PBF LTC1064-3CN#PBF HMC890ALP5E HMC892ALP5E HMC891ALP5E HMC882ALP5E HMC881ALP5E ADMV8420ACPZ ADMV8432ACPZ HMC881LP5ETR HMC882LP5ETR HMC1000LP5ETR HMC900LP5E LTC1068IN#PBF